Apollo 5100 is a single component, high viscosity ethoxyethyl cyanoacrylate adhesive. Low-odor and non-blooming characteristics make this product ideal for use in applications where vapor control is an issue.

### Physical Properties - Monomer (Uncured)

- **Base Compound**: Ethoxyethyl
- **Appearance**: Clear
- **Viscosity**: 900 +/- 200 cps cPs
- **Specific Gravity**: 1.06 g/cc
- **Flash Point**: 80°C/ 176°F
- **Shelf Life**: 12 mo
- **Storage Condition**: 20°C/ 68°F
- **RoHS-Compliant**: yes

### Physical Properties - Polymer (Cured)

- **Full Cure Time**: 24 hours
- **Appearance**: Clear
- **Service Temp Range**: -55 to 95 °C ( -67 to 203 °F)

### Setting Time

- **Steel**: 60 seconds
- **ABS**: 20 seconds
- **EPDM**: 20 seconds

### Performance of Cured Adhesive

<table>
<thead>
<tr>
<th>Substrate</th>
<th>N/mm²</th>
<th>PSI</th>
</tr>
</thead>
<tbody>
<tr>
<td>Steel</td>
<td>18.1</td>
<td>to 20.1</td>
</tr>
<tr>
<td>Rubber*</td>
<td>0.0</td>
<td>to 0.0</td>
</tr>
<tr>
<td>AL</td>
<td>13.9</td>
<td>to 15.4</td>
</tr>
<tr>
<td>PC**</td>
<td>6.5</td>
<td>to 8.6</td>
</tr>
<tr>
<td>PVC***</td>
<td>3.3</td>
<td>to 7.3</td>
</tr>
<tr>
<td>ABS**</td>
<td>4.0</td>
<td>to 5.3</td>
</tr>
</tbody>
</table>

*Rubber figures given are typical. Your results may vary by specific rubber type.

**Tested to ASTM 4501

***n/r = not recommended

### Specifications and Approvals

- **None**

### Hot Strength (%RT strength, tested at temperature)

![Graph showing Hot Strength over temperature range]

### Time Until Full Cure (% of RT strength)

![Graph showing Time Until Full Cure over time]

### Heat Aging (aged at temp indicated and tested @ 22°C)

![Graph showing Heat Aging over time]

### Performance Range, by Substrate

- **ABS**
- **PVC**
- **PC**
- **AL**
- **Rubber (typical)**
- **Steel**

![Graph showing Performance Range by Substrate]
Solvent Resistance

<table>
<thead>
<tr>
<th>Solvent</th>
<th>Example</th>
<th>Resistance</th>
</tr>
</thead>
<tbody>
<tr>
<td>Alcohol</td>
<td>Ethanol, Methanol</td>
<td>+ + +</td>
</tr>
<tr>
<td>Ester (aromatic)</td>
<td>Ethylacetate</td>
<td></td>
</tr>
<tr>
<td>Ketone (aromatic)</td>
<td>Acetone, Benzophenone</td>
<td></td>
</tr>
<tr>
<td>Aliphatic</td>
<td>Petrol, Heptanes, Hexane</td>
<td>+ + –</td>
</tr>
<tr>
<td>hydrocarbon (alkanes)</td>
<td>Benzyl, Toluol, Xylol</td>
<td>+ + –</td>
</tr>
<tr>
<td>Halogenated</td>
<td>Methylenechloride</td>
<td></td>
</tr>
<tr>
<td>hydrocarbons</td>
<td>Chloroform, Chlorobenzol</td>
<td>– – –</td>
</tr>
<tr>
<td>Weak aqueous acid</td>
<td>Nitrite, muriatic acid,</td>
<td>+ + (+ – – if concentrated)</td>
</tr>
<tr>
<td></td>
<td>sulphuric acid, phosphoric acid</td>
<td></td>
</tr>
<tr>
<td>Weak aqueous base</td>
<td>Sodium hydroxide solution, caustic potash</td>
<td>+ + (+ – – if concentrated)</td>
</tr>
</tbody>
</table>

General Instructions
Surfaces to be bonded should be clean and dry. Dispense a drop or drops to one surface only. Apply only enough to leave a thin film layer after compression. Press parts together and hold firmly for a few seconds. Good contact is essential. An adequate bond develops in less than one minute and maximum strength is attained in 24 hours. Wipe off excess adhesive from the top of the container and recap. Apollo products if left uncapped may deteriorate by contamination from moisture in the air. Because Apollo products cure by polymerization, whitening may appear on the surface of the container or the bonded materials. This will not affect adhesive performance.

Curing Performance
Ambient surface moisture initiates the curing process. Handling strength is reached in a short time, and will vary based on environmental conditions, bond line gap, and other factors. Product will continue to cure for at least 24 hours before full strength and solvent resistance is developed.

Storage
Products should be stored unopened in a cool, dry place out of direct sunlight. Products should be kept at room temperature away from direct light. Protect from extreme heat or cold, do not refrigerate.

Updated 1/20/2012

Note
The data contained herein are furnished for information only and are believed to be reliable. Cyberbond cannot assume responsibility for the results obtained by others over whose method Cyberbond does not control. It is the user’s responsibility to determine suitability for the product or of any production methods mentioned herein and to adopt such precautions as may be advisable for the protection of property and of persons against any hazards that may be involved in the handling and use thereof. In light of the foregoing, Cyberbond specifically disclaims all warranties of merchantability or fitness for a particular purpose arising from sale or use of Cyberbond products. Cyberbond specifically disclaims any liability for consequential or incidental damages of any kind, including loss of profits. The discussion herein of various processes or compositions is not to be interpreted as representation that they are free from domination of patents owned by others or as a license under any Cyberbond patents which may cover such processes or compositions. We recommend that each prospective user test the proposed application to determine its suitability for the purpose intended prior to incorporating any product or application in its manufacturing process using the data as a guide.

For safe handling information on this product, consult the Material Safety Data Sheet (MSDS)

Cyberbond, LLC
401 N Raddant Road
Batavia, IL 60510
630.761.8900 tel
www.cyberbond1.com

Cyberbond Europe GmbH
Werner-von-Siemens Straße 2
D - 31515 Wunstorf
Germany
49 / 50 31 / 95 66 - 0 tel
www.cyberbond.de